**LM2524D/LM3524D Regulating Pulse Width Modulator**

Check for Samples: LM2524D, LM3524D

### FEATURES

- Fully Interchangeable With Standard LM3524 Family
- ±1% Precision 5V Reference With Thermal Shut-Down
- Output Current to 200 mA DC
- 60V Output Capability
- Wide Common Mode Input Range for Error-Amp
- One Pulse per Period (Noise Suppression)
- Improved Max. Duty Cycle at High Frequencies
- Double Pulse Suppression
- Synchronize Through Pin 3

### DESCRIPTION

The LM3524D family is an improved version of the industry standard LM3524. It has improved specifications and additional features yet is pin for pin compatible with existing 3524 families. New features reduce the need for additional external circuitry often required in the original version.

The LM3524D has a ±1% precision 5V reference. The current carrying capability of the output drive transistors has been raised to 200 mA while reducing $V_{CE\text{sat}}$ and increasing $V_{CE}$ breakdown to 60V. The common mode voltage range of the error-amp has been raised to 5.5V to eliminate the need for a resistive divider from the 5V reference.

In the LM3524D the circuit bias line has been isolated from the shut-down pin. This prevents the oscillator pulse amplitude and frequency from being disturbed by shut-down. Also at high frequencies ($\approx 300$ kHz) the max. duty cycle per output has been improved to 44% compared to 35% max. duty cycle in other 3524s.

In addition, the LM3524D can now be synchronized externally, through pin 3. Also a latch has been added to insure one pulse per period even in noisy environments. The LM3524D includes double pulse suppression logic that insures when a shut-down condition is removed the state of the T-flip-flop will change only after the first clock pulse has arrived. This feature prevents the same output from being pulsed twice in a row, thus reducing the possibility of core saturation in push-pull designs.

**Connection Diagram**

![Connection Diagram](image)

**Figure 1. Top View**

See Package Number NFG

See Package Number D
Block Diagram
These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**Absolute Maximum Ratings**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>LM2524D</th>
<th>LM3524D</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply Voltage</td>
<td>40V</td>
<td></td>
</tr>
<tr>
<td>Collector Supply Voltage</td>
<td></td>
<td>55V</td>
</tr>
<tr>
<td>LM2524D</td>
<td>200 mA</td>
<td></td>
</tr>
<tr>
<td>LM3524D</td>
<td></td>
<td>40V</td>
</tr>
<tr>
<td>Output Current DC (each)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Oscillator Charging Current (Pin 7)</td>
<td>5 mA</td>
<td></td>
</tr>
<tr>
<td>Internal Power Dissipation</td>
<td>1W</td>
<td></td>
</tr>
<tr>
<td>Operating Junction Temperature Range</td>
<td></td>
<td></td>
</tr>
<tr>
<td>LM2524D</td>
<td>−40°C to +125°C</td>
<td></td>
</tr>
<tr>
<td>LM3524D</td>
<td>0°C to +125°C</td>
<td></td>
</tr>
<tr>
<td>Maximum Junction Temperature</td>
<td>150°C</td>
<td></td>
</tr>
<tr>
<td>Storage Temperature Range</td>
<td>−65°C to +150°C</td>
<td></td>
</tr>
<tr>
<td>Lead Temperature (Soldering 4 sec.)</td>
<td>NFG, D Pkg.</td>
<td>260°C</td>
</tr>
</tbody>
</table>

(1) Absolute maximum ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

(3) For operation at elevated temperatures, devices in the NFG package must be derated based on a thermal resistance of 86 °C/W, junction to ambient. Devices in the D package must be derated at 125 °C/W, junction to ambient.

**Electrical Characteristics**

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>LM2524D</th>
<th>LM3524D</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>V&lt;sub&gt;REF&lt;/sub&gt;</td>
<td>Output Voltage</td>
<td></td>
<td>5</td>
<td>4.85</td>
<td>4.80</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5.15</td>
<td>5.20</td>
</tr>
<tr>
<td>V&lt;sub&gt;RLline&lt;/sub&gt;</td>
<td>Line Regulation</td>
<td>V&lt;sub&gt;IN&lt;/sub&gt; = 8V to 40V</td>
<td>10</td>
<td>15</td>
<td>30</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>10</td>
<td>25</td>
<td>50</td>
</tr>
<tr>
<td>V&lt;sub&gt;Rload&lt;/sub&gt;</td>
<td>Load Regulation</td>
<td>I&lt;sub&gt;L&lt;/sub&gt; = 0 mA to 20 mA</td>
<td>10</td>
<td>15</td>
<td>25</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>10</td>
<td>25</td>
<td>50</td>
</tr>
<tr>
<td>ΔV&lt;sub&gt;IN&lt;/sub&gt;/ΔV&lt;sub&gt;REF&lt;/sub&gt;</td>
<td>Ripple Rejection</td>
<td>f = 120 Hz</td>
<td>66</td>
<td>66</td>
<td></td>
</tr>
<tr>
<td>I&lt;sub&gt;OS&lt;/sub&gt;</td>
<td>Short Circuit Current</td>
<td>V&lt;sub&gt;REF&lt;/sub&gt; = 0</td>
<td>25</td>
<td>25</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>50</td>
<td>50</td>
<td></td>
</tr>
<tr>
<td>N&lt;sub&gt;O&lt;/sub&gt;</td>
<td>Output Noise</td>
<td>10 Hz ≤ f ≤ 10 kHz</td>
<td>40</td>
<td>100</td>
<td>40</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>100</td>
<td>100</td>
<td>100</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Long Term Stability</td>
<td>T&lt;sub&gt;A&lt;/sub&gt; = 125°C</td>
<td>20</td>
<td>20</td>
</tr>
<tr>
<td>f&lt;sub&gt;Osc&lt;/sub&gt;</td>
<td>Max. Freq.</td>
<td></td>
<td>550</td>
<td>500</td>
<td>350</td>
</tr>
<tr>
<td></td>
<td>Initial Accuracy</td>
<td>R&lt;sub&gt;T&lt;/sub&gt; = 1k, C&lt;sub&gt;T&lt;/sub&gt; = 0.001 µF&lt;sup&gt;(4)&lt;/sup&gt;</td>
<td>17.5</td>
<td>17.5</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>R&lt;sub&gt;T&lt;/sub&gt; = 5.6k, C&lt;sub&gt;T&lt;/sub&gt; = 0.01 µF&lt;sup&gt;(4)&lt;/sup&gt;</td>
<td>20</td>
<td>20</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>R&lt;sub&gt;T&lt;/sub&gt; = 2.7k, C&lt;sub&gt;T&lt;/sub&gt; = 0.01 µF&lt;sup&gt;(4)&lt;/sup&gt;</td>
<td>34</td>
<td>30</td>
<td></td>
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<td></td>
<td></td>
<td>42</td>
<td>46</td>
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</tr>
</tbody>
</table>

(1) Unless otherwise stated, these specifications apply for T<sub>A</sub> = T<sub>J</sub> = 25°C. Boldface numbers apply over the rated temperature range: LM2524D is −40°C to 85°C and LM3524D is 0°C to 70°C. V<sub>IN</sub> = 20V and f<sub>Osc</sub> = 20 kHz.

(2) Tested limits are ensured and 100% tested in production.

(3) Design limits are ensured (but not 100% production tested) over the indicated temperature and supply voltage range. These limits are not used to calculate outgoing quality level.

(4) The value of a C<sub>T</sub> capacitor can vary with frequency. Careful selection of this capacitor must be made for high frequency operation. Polystyrene was used in this test. NPO ceramic or polypropylene can also be used.
## Electrical Characteristics \(^{(1)}\) (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>LM2524D</td>
<td>LM3524D</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Typ</td>
<td>Test Limit (^{(2)})</td>
</tr>
<tr>
<td>Δ(f_{OSC})</td>
<td>Freq. Change with (V_{IN})</td>
<td>(V_{IN} = 8 \text{ to } 40\text{V})</td>
<td>0.5</td>
</tr>
<tr>
<td>Δ(f_{OSC})</td>
<td>Freq. Change with Temp.</td>
<td>(T_{A} = -55^\circ\text{C to } +125^\circ\text{C})</td>
<td>5</td>
</tr>
<tr>
<td>(V_{OSC})</td>
<td>Output Amplitude (Pin 3) (^{(5)})</td>
<td>(R_T = 5.6k, C_T = 0.01\mu\text{F})</td>
<td>3</td>
</tr>
<tr>
<td>(I_{PW})</td>
<td>Output Pulse Width (Pin 3)</td>
<td>(R_T = 5.6k, C_T = 0.01\mu\text{F})</td>
<td>0.5</td>
</tr>
<tr>
<td></td>
<td>Sawtooth Peak Voltage</td>
<td>(R_T = 5.6k, C_T = 0.01\mu\text{F})</td>
<td>3.4</td>
</tr>
<tr>
<td></td>
<td>Sawtooth Valley Voltage</td>
<td>(R_T = 5.6k, C_T = 0.01\mu\text{F})</td>
<td>1.1</td>
</tr>
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</table>

### ERROR-AMP SECTION

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>(V_{IO})</td>
<td>Input Offset Voltage</td>
<td>(V_{CM} = 2.5\text{V})</td>
<td>2</td>
</tr>
<tr>
<td>(I_{IB})</td>
<td>Input Bias Current</td>
<td>(V_{CM} = 2.5\text{V})</td>
<td>0.5</td>
</tr>
<tr>
<td>(I_{O})</td>
<td>Input Offset Current</td>
<td>(V_{CM} = 2.5\text{V})</td>
<td>0.5</td>
</tr>
<tr>
<td>(I_{COSI})</td>
<td>Compensation Current (Sink)</td>
<td>(V_{I(I)} - V_{I(IN)} = 150\text{mV})</td>
<td>65</td>
</tr>
<tr>
<td>(I_{COSO})</td>
<td>Compensation Current (Source)</td>
<td>(V_{I(IN)} - V_{I(IN)} = 150\text{mV})</td>
<td>-125</td>
</tr>
<tr>
<td></td>
<td></td>
<td>(R_T = 5.6k, C_T = 0.01\mu\text{F})</td>
<td>-95</td>
</tr>
<tr>
<td></td>
<td></td>
<td>(R_T = 1k, C_T = 0.001\mu\text{F})</td>
<td>-65</td>
</tr>
<tr>
<td>(A_{VOL})</td>
<td>Open Loop Gain</td>
<td>(R_L = \infty, V_{CM} = 2.5\text{V})</td>
<td>80</td>
</tr>
<tr>
<td>(V_{CMR})</td>
<td>Common Mode Input Voltage Range</td>
<td></td>
<td>1.5</td>
</tr>
<tr>
<td>(CMRR)</td>
<td>Common Mode Rejection Ratio</td>
<td></td>
<td>5.5</td>
</tr>
<tr>
<td>(G_{BW})</td>
<td>Unity Gain Bandwidth</td>
<td>(A_{VOL} = 0\text{dB, } V_{CM} = 2.5\text{V})</td>
<td>3</td>
</tr>
<tr>
<td>(V_{O})</td>
<td>Output Voltage Swing</td>
<td>(R_L = \infty)</td>
<td>0.5</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>5.5</td>
</tr>
<tr>
<td>(PSRR)</td>
<td>Power Supply Rejection Ratio</td>
<td>(V_{IN} = 8 \text{ to } 40\text{V})</td>
<td>80</td>
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</table>

### COMPARATOR SECTION

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<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>(I_{ONV_{OSC}})</td>
<td>Minimum Duty Cycle</td>
<td>(\text{Pin 9} = 0.8\text{V, } [R_T = 5.6k, C_T = 0.01\mu\text{F}])</td>
<td>0</td>
</tr>
<tr>
<td>(I_{ONV_{OSC}})</td>
<td>Maximum Duty Cycle</td>
<td>(\text{Pin 9} = 3.9\text{V, } [R_T = 5.6k, C_T = 0.01\mu\text{F}])</td>
<td>49</td>
</tr>
<tr>
<td>(I_{ONV_{OSC}})</td>
<td>Maximum Duty Cycle</td>
<td>(\text{Pin 9} = 3.9\text{V, } [R_T = 1k, C_T = 0.001\mu\text{F}])</td>
<td>44</td>
</tr>
<tr>
<td>(V_{COMPZ})</td>
<td>Input Threshold</td>
<td>Zero Duty Cycle</td>
<td>1</td>
</tr>
<tr>
<td>(V_{COMP})</td>
<td>Input Threshold (Pin 9)</td>
<td>Maximum Duty Cycle</td>
<td>3.5</td>
</tr>
<tr>
<td>(I_{IB})</td>
<td>Input Bias Current</td>
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<td>-1</td>
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</tbody>
</table>

### CURRENT LIMIT SECTION

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>(V_{SEN})</td>
<td>Sense Voltage</td>
<td>(V_{(\text{Pin 2})} - V_{(\text{Pin 1})} \geq 150\text{mV})</td>
<td>180</td>
</tr>
<tr>
<td></td>
<td></td>
<td>(200)</td>
<td>(200)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>(220)</td>
<td>(220)</td>
</tr>
<tr>
<td>(TC-V_{sense})</td>
<td>Sense Voltage T.C.</td>
<td>(V_5 - V_4 = 300\text{mV})</td>
<td>-0.7</td>
</tr>
<tr>
<td></td>
<td></td>
<td>(1)</td>
<td>(1)</td>
</tr>
</tbody>
</table>

\(^{(5)}\) OSC amplitude is measured open circuit. Available current is limited to 1 mA so care must be exercised to limit capacitive loading of fast pulses.

Submit Documentation Feedback

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Product Folder Links: **LM2524D** **LM3524D**
## Electrical Characteristics (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>LM2524D</th>
<th>LM3524D</th>
<th>Units</th>
</tr>
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<tbody>
<tr>
<td></td>
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<td></td>
<td>Typ</td>
<td>Tested Limit</td>
<td>Design Limit</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Limit (2)</td>
<td>Limit (3)</td>
<td></td>
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### SHUT DOWN SECTION

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<th>LM3524D</th>
<th>Units</th>
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<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>Typ</td>
<td>Tested Limit</td>
<td>Design Limit</td>
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<td></td>
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<td></td>
<td>Limit (2)</td>
<td>Limit (3)</td>
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<td></td>
</tr>
</tbody>
</table>

- **V<sub>SD</sub>** High Input Voltage
  - $V_{(Pin \ 2)} - V_{(Pin \ 1)} \geq 150 \text{ mV}$
  - LM2524D: Typ = 1, Limit (2) = 0.5, Limit (3) = 1.5
  - LM3524D: Typ = 1, Limit (2) = 1.5
  - Units: $V_{\text{Min}}$

- **I<sub>SD</sub>** High Input Current
  - $I_{(pin \ 10)}$
  - LM2524D: Typ = 1
  - LM3524D: Typ = 1
  - Units: mA

### OUTPUT SECTION (EACH OUTPUT)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>LM2524D</th>
<th>LM3524D</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>Typ</td>
<td>Tested Limit</td>
<td>Design Limit</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Limit (2)</td>
<td>Limit (3)</td>
<td></td>
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</tr>
</tbody>
</table>

- **V<sub>DES</sub>** Collector Emitter Voltage Breakdown
  - $I_C \leq 100 \mu A$
  - LM2524D: Typ = 55, Limit (2) = 40
  - Units: $V_{\text{Min}}$

- **I<sub>CES</sub>** Collector Leakage Current
  - $V_{CE} = 60 \text{ V}$
  - $V_{CE} = 55 \text{ V}$
  - $V_{CE} = 40 \text{ V}$
  - LM2524D: Typ = 0.1, Limit (2) = 50
  - Limit (3) = 0.1
  - LM3524D: Typ = 50
  - Units: $\mu A_{\text{Max}}$

- **V<sub>DESAT</sub>** Saturation Voltage
  - $I_E = 20 \text{ mA}$
  - $I_E = 200 \text{ mA}$
  - LM2524D: Typ = 0.2, Limit (2) = 0.5
  - Limit (3) = 0.2
  - LM3524D: Typ = 0.7
  - LM2524D: Typ = 1.5
  - LM3524D: Typ = 2.5
  - Units: $V_{\text{Max}}$

- **V<sub>EO</sub>** Emitter Output Voltage
  - $I_E = 50 \text{ mA}$
  - LM2524D: Typ = 18
  - LM3524D: Typ = 17
  - Units: $V_{\text{Min}}$

- **t<sub>R</sub>** Rise Time
  - $V_{IN} = 20 \text{ V}$,
  - $I_E = -250 \mu A$
  - $R_C = 2k$
  - LM2524D: Typ = 200
  - Unit: ns

- **t<sub>F</sub>** Fall Time
  - $R_C = 2k$
  - LM2524D: Typ = 100
  - Unit: ns

### SUPPLY CHARACTERISTICS SECTION

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>LM2524D</th>
<th>LM3524D</th>
<th>Units</th>
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<td>Typ</td>
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<td>Design Limit</td>
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<td></td>
<td>Limit (2)</td>
<td>Limit (3)</td>
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</tr>
</tbody>
</table>

- **V<sub>IN</sub>** Input Voltage Range
  - After Turn-on
  - LM2524D: Typ = 8
  - LM3524D: Typ = 8
  - Units: $V_{\text{Min}}$

- **T** Thermal Shutdown Temp.
  - (6)
  - LM2524D: Typ = 160
  - LM3524D: Typ = 160
  - Units: °C

- **I<sub>IN</sub>** Stand By Current
  - $V_{IN} = 40 \text{ V}$ (7)
  - LM2524D: Typ = 5
  - LM3524D: Typ = 5
  - Units: mA

---

(6) For operation at elevated temperatures, devices in the NFG package must be derated based on a thermal resistance of 86°C/W, junction to ambient. Devices in the D package must be derated at 125°C/W, junction to ambient.

(7) Pins 1, 4, 7, 8, 11, and 14 are grounded; Pin 2 = 2V. All other inputs and outputs open.
Typical Performance Characteristics

Switching Transistor Peak Output Current vs Temperature

Maximum Average Power Dissipation (NFG, D Packages)

Maximum & Minimum Duty Cycle Threshold Voltage

Output Transistor Saturation Voltage

Output Transistor Emitter Voltage

Reference Transistor Peak Output Current
Typical Performance Characteristics (continued)

**Standby Current vs Voltage**

![Figure 8](image)

**Standby Current vs Temperature**

![Figure 9](image)

**Current Limit Sense Voltage**

![Figure 10](image)
**Functional Description**

**Internal Voltage Regulator**

The LM3524D has an on-chip 5V, 50 mA, short circuit protected voltage regulator. This voltage regulator provides a supply for all internal circuitry of the device and can be used as an external reference.

For input voltages of less than 8V the 5V output should be shorted to pin 15, $V_{IN}$, which disables the 5V regulator. With these pins shorted the input voltage must be limited to a maximum of 6V. If input voltages of 6V–8V are to be used, a pre-regulator, as shown in Figure 11, must be added.

*Minimum $C_O$ of 10 μF required for stability.

**Oscillator**

The LM3524D provides a stable on-board oscillator. Its frequency is set by an external resistor, $R_T$ and capacitor, $C_T$. A graph of $R_T$, $C_T$ vs oscillator frequency is shown in Figure 12. The oscillator's output provides the signals for triggering an internal flip-flop, which directs the PWM information to the outputs, and a blanking pulse to turn off both outputs during transitions to ensure that cross conduction does not occur. The width of the blanking pulse, or dead time, is controlled by the value of $C_T$, as shown in Figure 13. The recommended values of $R_T$ are 1.8 kΩ to 100 kΩ, and for $C_T$, 0.001 μF to 0.1 μF.

If two or more LM3524D's must be synchronized together, the easiest method is to interconnect all pin 3 terminals, tie all pin 7's (together) to a single $C_T$, and leave all pin 6's open except one which is connected to a single $R_T$. This method works well unless the LM3524D's are more than 6″ apart.

A second synchronization method is appropriate for any circuit layout. One LM3524D, designated as master, must have its $R_T C_T$ set for the correct period. The other slave LM3524D(s) should each have an $R_T C_T$ set for a 10% longer period. All pin 3's must then be interconnected to allow the master to properly reset the slave units.

The oscillator may be synchronized to an external clock source by setting the internal free-running oscillator frequency 10% slower than the external clock and driving pin 3 with a pulse train (approx. 3V) from the clock. Pulse width should be greater than 50 ns to insure full synchronization.

![Figure 11](image1)

![Figure 12](image2)
Error Amplifier

The error amplifier is a differential input, transconductance amplifier. Its gain, nominally 86 dB, is set by either feedback or output loading. This output loading can be done with either purely resistive or a combination of resistive and reactive components. A graph of the amplifier's gain vs output load resistance is shown in Figure 14.

The output of the amplifier, or input to the pulse width modulator, can be overridden easily as its output impedance is very high ($Z_o \approx 5 \text{ M}\Omega$). For this reason a DC voltage can be applied to pin 9 which will override the error amplifier and force a particular duty cycle to the outputs. An example of this could be a non-regulating motor speed control where a variable voltage was applied to pin 9 to control motor speed. A graph of the output duty cycle vs the voltage on pin 9 is shown in Figure 15.

The duty cycle is calculated as the percentage ratio of each output's ON-time to the oscillator period. Paralleling the outputs doubles the observed duty cycle.
The amplifier's inputs have a common-mode input range of 1.5V–5.5V. The on board regulator is useful for biasing the inputs to within this range.

**Current Limiting**

The function of the current limit amplifier is to override the error amplifier's output and take control of the pulse width. The output duty cycle drops to about 25% when a current limit sense voltage of 200 mV is applied between the $+C_L$ and $-C_L$ sense terminals. Increasing the sense voltage approximately 5% results in a 0% output duty cycle. Care should be taken to ensure the $-0.7V$ to $+1.0V$ input common-mode range is not exceeded.

In most applications, the current limit sense voltage is produced by a current through a sense resistor. The accuracy of this measurement is limited by the accuracy of the sense resistor, and by a small offset current, typically 100 $\mu$A, flowing from $+CL$ to $-CL$.

**Output Stages**

The outputs of the LM3524D are NPN transistors, capable of a maximum current of 200 mA. These transistors are driven 180° out of phase and have non-committed open collectors and emitters as shown in Figure 16.
Typical Applications

Figure 17. Positive Regulator, Step-Up Basic Configuration ($I_{\text{IN(MAX)}} = 80 \text{ mA}$)

Design Equations

$$R_F = 5k \left( \frac{V_O}{2.5} - 1 \right)$$

$$f_{\text{OSC}} = \frac{1}{R_T C_T}$$

$$L_1 = \frac{2.5 V_{IN}^2 (V_O - V_{IN})}{f_{\text{OSC}} V_O V_O}$$

$$C_O = \frac{I_O (V_O - V_{IN})}{f_{\text{OSC}} \Delta V_O V_O}$$

$$I_{O(\text{MAX})} = \frac{V_{IN}}{V_O}$$

Figure 18. Positive Regulator, Step-Up Boosted Current Configuration

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Product Folder Links: LM2524D LM3524D
Figure 19. Positive Regulator, Step-Down Basic Configuration \( (I_{IN(MAX)} = 80 \text{ mA}) \)

**Design Equations**

\[
R_F = 5 \text{ k} \Omega \left( \frac{V_O}{2.5} - 1 \right)
\]

Current Limit Sense Volt

\[
R_{CL} = \frac{1}{I_{O(MAX)}}
\]

\[
I_{OSC} = \frac{1}{R_T C_T}
\]

\[
L_1 = \frac{2.5 V_O(V_{IN} - V_O)}{I_0 V_{IN} I_{OSC}}
\]

\[
C_0 = \frac{(V_{IN} - V_O) V_O T^2}{8 A V_O V_{IN} L_1}
\]

\[
I_{O(MAX)} = I_{IN} V_{O}
\]

Figure 20. Positive Regulator, Step-Down Boosted Current Configuration
Basic Switching Regulator Theory and Applications

The basic switching regulator circuit is shown in Figure 22, along with a practical circuit design using the LM3524D in Figure 25.

The circuit works as follows: Q1 is used as a switch, which has ON and OFF times controlled by the pulse width modulator. When Q1 is ON, power is drawn from \( V_{IN} \) and supplied to the load through L1; \( V_A \) is at approximately \( V_{IN} \), D1 is reverse biased, and \( C_o \) is charging. When Q1 turns OFF the inductor L1 will force \( V_A \) negative to keep the current flowing in it, D1 will start conducting and the load current will flow through D1 and L1. The voltage at \( V_A \) is smoothed by the L1, \( C_o \) filter giving a clean DC output. The current flowing through L1 is equal to the nominal DC load current plus some \( \Delta I_L \) which is due to the changing voltage across it. A good rule of thumb is to set \( \Delta I_{L,P-P} \approx 40\% \times I_0 \).
Figure 23. Relation of Switch Timing to Inductor Current in Step-Down Regulator

From the relation $V_L = L \frac{dI}{dt}$, $\Delta I_L = \frac{V_L T}{L_1}$
\[
\Delta I_L^+ = \frac{(V_{IN} - V_o) t_{ON}}{L_1}, \quad \Delta I_L^- = \frac{V_o t_{OFF}}{L_1}
\]

Neglecting $V_{SAT}$, $V_D$, and settling $\Delta I_L^+ = \Delta I_L^-$;
\[
V_o \approx V_{IN} \left( \frac{t_{ON}}{t_{OFF} + t_{ON}} \right) = V_{IN} \left( \frac{t_{ON}}{T} \right);
\]
where $T =$ Total Period

The above shows the relation between $V_{IN}$, $V_o$ and duty cycle.

\[
l_{IN(DC)} = I_{OUT(DC)} \left( \frac{t_{ON}}{t_{ON} + t_{OFF}} \right),
\]
as Q1 only conducts during $t_{ON}$.

\[
P_{IN} = l_{IN(DC)} V_{IN} = (I_{0(DC)}) \left( \frac{t_{ON}}{t_{ON} + t_{OFF}} \right) V_{IN}
\]
\[
P_o = I_o V_o
\]
The efficiency, $\eta$, of the circuit is:

\[
\eta_{MAX} = \frac{P_o}{P_{IN}} = \frac{I_o V_o}{I_0 \left( \frac{t_{ON}}{t_{ON} + t_{OFF}} \right) V_{IN} + \left( \frac{V_{SAT} t_{ON} + V_D t_{OFF}}{T} \right) I_o}
\]
\[
= \frac{V_o}{V_o + 1}
\]
for $V_{SAT} = V_D = 1V$.

$\eta_{MAX}$ will be further decreased due to switching losses in Q1. For this reason Q1 should be selected to have the maximum possible $f_T$, which implies very fast rise and fall times.

Calculating Inductor L1

\[
t_{ON} \approx \frac{(\Delta I_L^+ \times L_1)}{(V_{IN} - V_o)}, \quad t_{OFF} \approx \frac{(\Delta I_L^- \times L_1)}{V_o}
\]
\[
\frac{t_{ON} + t_{OFF}}{T} = \frac{((\Delta I_L^+ \times L_1) + (\Delta I_L^- \times L_1))}{V_o} \left( \frac{0.4 I_o L_1}{V_{IN} - V_o} \right) \left( \frac{0.4 I_o L_1}{V_o} \right)
\]
Since $\Delta I_L^+ = \Delta I_L^- = 0.4 I_o$

Solving the above for $L_1$
\[ L_1 = \frac{2.5 V_o (V_{IN} - V_o)}{I_o V_{IN} f} \]  

(10)

where: \( L_1 \) is in Henrys
\( f \) is switching frequency in Hz

Also, see LM1578 data sheet for graphical methods of inductor selection.

**Calculating Output Filter Capacitor \( C_o \)**

Figure 23 shows \( L_1 \)'s current with respect to \( Q1 \)'s \( t_{ON} \) and \( t_{OFF} \) times (\( V_A \) is at the collector of \( Q1 \)). This current must flow to the load and \( C_o \). \( C_o \)'s current will then be the difference between \( I_L \), and \( I_o \).

\[ I_{C_o} = I_L - I_o \]  

(11)

From Figure 23 it can be seen that current will be flowing into \( C_o \) for the second half of \( t_{ON} \) through the first half of \( t_{OFF} \), or a time, \( t_{ON}/2 + t_{OFF}/2 \). The current flowing for this time is \( \Delta I_L/4 \). The resulting \( \Delta V_{op} \) or \( \Delta V_o \) is described by:

\[ \Delta V_{op} = \frac{1}{2} \times \frac{\Delta I_L}{4} \times \left( \frac{t_{ON} + t_{OFF}}{2} \right) \]

\[ = \frac{\Delta I_L}{2} \times \frac{t_{ON} + t_{OFF}}{2} \]

Since \( \Delta I_L = \frac{V_o (T - t_{ON})}{L_1} \) and \( t_{ON} = \frac{V_o T}{V_{IN}} \)

\[ \Delta V_{op} = \frac{V_o}{4C L_1} \left( T - \frac{V_o T}{V_{IN}} \right) \left( \frac{I}{2} \right) = \frac{V_o}{8V_{IN}C_o L_1} \]  

or

\[ C_o = \frac{(V_{IN} - V_o) V_o T^2}{8 \Delta V_o V_{IN} L_1} \]

(12)

where: \( C \) is in farads, \( T \) is switching frequency
\( \Delta V_o \) is p-p output ripple

For best regulation, the inductor's current cannot be allowed to fall to zero. Some minimum load current \( I_o \), and thus inductor current, is required as shown below:

\[ I_{o(MIN)} = \frac{(V_{IN} - V_o) t_{ON}}{2L_1} = \frac{(V_{IN} - V_o) V_o}{2fV_{IN}L_1} \]  

(13)

\[ \Delta I_L = \frac{(V_{IN} - V_o)t_{ON}}{L_1} \]

\[ I_o \text{(MIN)} \]

Figure 24. Inductor Current Slope in Step-Down Regulator

A complete step-down switching regulator schematic, using the LM3524D, is illustrated in Figure 25. Transistors \( Q1 \) and \( Q2 \) have been added to boost the output to 1A. The 5V regulator of the LM3524D has been divided in half to bias the error amplifier's non-inverting input to within its common-mode range. Since each output transistor is on for half the period, actually 45%, they have been paralleled to allow longer possible duty cycle, up to 90%. This makes a lower possible input voltage. The output voltage is set by:

\[ V_o = V_{NI} \left( 1 + \frac{R_1}{R_2} \right) \]

(14)

where \( V_{NI} \) is the voltage at the error amplifier's non-inverting input.
Resistor R3 sets the current limit to:

$$\frac{200 \text{ mV}}{R3} = \frac{200 \text{ mV}}{0.15} = 1.3 \text{A.}$$  \hspace{1cm} (15)

Figure 26 and Figure 27 show a PC board layout and stuffing diagram for the 5V, 1A regulator of Figure 25. The regulator’s performance is listed in Table 1.

Table 1.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Conditions</th>
<th>Typical Characteristics</th>
</tr>
</thead>
<tbody>
<tr>
<td>Output Voltage</td>
<td>$V_{IN} = 10\text{V}, I_o = 1\text{A}$</td>
<td>5V</td>
</tr>
<tr>
<td>Switching Frequency</td>
<td>$V_{IN} = 10\text{V}, I_o = 1\text{A}$</td>
<td>20 kHz</td>
</tr>
<tr>
<td>Short Circuit Current Limit</td>
<td>$V_{IN} = 10\text{V}$</td>
<td>1.3A</td>
</tr>
<tr>
<td>Load Regulation</td>
<td>$V_{IN} = 10\text{V}$</td>
<td>3 mV</td>
</tr>
<tr>
<td>Line Regulation</td>
<td>$\Delta V_{IN} = 10 - 20\text{V}$, $I_o = 1\text{A}$</td>
<td>6 mV</td>
</tr>
<tr>
<td>Efficiency</td>
<td>$V_{IN} = 10\text{V}, I_o = 1\text{A}$</td>
<td>80%</td>
</tr>
<tr>
<td>Output Ripple</td>
<td>$V_{IN} = 10\text{V}, I_o = 1\text{A}$</td>
<td>10 mVp-p</td>
</tr>
</tbody>
</table>

*Mounted to Staver Heatsink No. V5-1.
Q1 = BD344
Q2 = 2N5023
L1 = >40 turns No. 22 wire on Ferroxcube No. K300502 Torroid core.

Figure 25. 5V, 1 Amp Step-Down Switching Regulator
The Step-Up Switching Regulator

Figure 28 shows the basic circuit for a step-up switching regulator. In this circuit Q1 is used as a switch to alternately apply $V_{IN}$ across inductor L1. During the time, $t_{ON}$, Q1 is ON and energy is drawn from $V_{IN}$ and stored in L1; D1 is reverse biased and $I_o$ is supplied from the charge stored in $C_o$. When Q1 opens, $t_{OFF}$, voltage V1 will rise positively to the point where D1 turns ON. The output current is now supplied through L1, D1 to the load and any charge lost from $C_o$ during $t_{ON}$ is replenished. Here also, as in the step-down regulator, the current through L1 has a DC component plus some $\Delta I_L$. $\Delta I_L$ is again selected to be approximately 40% of $I_L$. Figure 29 shows the inductor's current in relation to Q1's ON and OFF times.
Since \( \Delta I_L^+ = \Delta I_L^- \), \( V_{IN} t_{ON} = V_o t_{OFF} - V_{IN} t_{OFF} \), and neglecting \( V_{SAT} \) and \( V_{D1} \),

\[
V_o = V_{IN} \left( 1 + \frac{t_{ON}}{t_{OFF}} \right)
\]  

(17)

The above equation shows the relationship between \( V_{IN} \), \( V_o \) and duty cycle.

In calculating input current \( I_{IN(DC)} \), which equals the inductor's DC current, assume first 100% efficiency:

\[
P_{IN} = I_{IN(DC)} V_{IN}
\]

\[
P_{OUT} = I_o V_o = I_o V_{IN} \left( 1 + \frac{t_{ON}}{t_{OFF}} \right)
\]

(18)

for \( \eta = 100\% \), \( P_{OUT} = P_{IN} \)

\[
I_o V_{IN} \left( 1 + \frac{t_{ON}}{t_{OFF}} \right) = I_{IN(DC)} V_{IN}
\]

\[
I_{IN(DC)} = I_o \left( 1 + \frac{t_{ON}}{t_{OFF}} \right)
\]

(19)

This equation shows that the input, or inductor, current is larger than the output current by the factor \( 1 + \frac{t_{ON}}{t_{OFF}} \). Since this factor is the same as the relation between \( V_o \) and \( V_{IN} \), \( I_{IN(DC)} \) can also be expressed as:

\[
I_{IN(DC)} = I_o \left( \frac{V_o}{V_{IN}} \right)
\]

(20)
So far it is assumed \( \eta = 100\% \), where the actual efficiency or \( \eta_{\text{MAX}} \) will be somewhat less due to the saturation voltage of Q1 and forward on voltage of D1. The internal power loss due to these voltages is the average \( I_L \) current flowing, or \( I_{\text{IN}} \), through either \( V_{\text{SAT}} \) or \( V_{\text{D1}} \). For \( V_{\text{SAT}} = V_{\text{D1}} = 1V \) this power loss becomes \( I_{\text{IN(DC)}} (1V) \). \( \eta_{\text{MAX}} \) is then:

\[
\eta_{\text{MAX}} = \frac{P_o}{P_{\text{IN}}} = \frac{V_{o10}^2}{V_{o10}^2 + I_{\text{IN}} V_{\text{SAT}} (1V)} = \frac{V_{o10}^2}{V_{o10}^2 + I_{\text{IN}} (1 + \frac{t_{\text{ON}}}{t_{\text{OFF}}})}
\]

(21)

From \( V_o = V_{\text{IN}} (1 + \frac{t_{\text{ON}}}{t_{\text{OFF}}}) \)

\[
\eta_{\text{MAX}} = \frac{V_{\text{IN}}}{V_{\text{IN}} + 1}
\]

(22)

This equation assumes only DC losses, however \( \eta_{\text{MAX}} \) is further decreased because of the switching time of Q1 and D1.

In calculating the output capacitor \( C_o \) it can be seen that \( C_o \) supplies \( I_o \) during \( t_{\text{ON}} \). The voltage change on \( C_o \) during this time will be some \( \Delta V_c = \Delta V_o \) or the output ripple of the regulator. Calculation of \( C_o \) is:

\[
\Delta V_o = \frac{I_{\text{ON}}}{C_o} \text{ or } C_o = \frac{I_{\text{ON}}}{\Delta V_o}
\]

From \( V_o = V_{\text{IN}} \left( \frac{T}{t_{\text{OFF}}} \right); t_{\text{OFF}} = \frac{V_{\text{IN}} T}{V_o} \)

where \( T = t_{\text{ON}} + t_{\text{OFF}} = \frac{1}{f} \)

\[ t_{\text{ON}} = T - \frac{V_{\text{IN}} T}{V_o} = T \left( \frac{V_o - V_{\text{IN}}}{V_o} \right) \]

therefore:

\[
C_o = \frac{I_o T \left( \frac{V_o - V_{\text{IN}}}{V_o} \right)}{\Delta V_o} = \frac{I_o (V_o - V_{\text{IN}})}{f \Delta V_o V_o}
\]

(23)

where: \( C_o \) is in farads, \( f \) is the switching frequency, \( \Delta V_o \) is the p-p output ripple

Calculation of inductor \( L_1 \) is as follows:

\[
L_1 = \frac{V_{\text{IN}} I_{\text{ON}}}{\Delta L_{\text{p-p}}} \text{, since during } t_{\text{ON}}.
\]

(24)

\( V_{\text{IN}} \) is applied across \( L_1 \)

\[
\Delta L_{\text{p-p}} = 0.4 I_L = 0.41 I_{\text{IN}} = 0.4 I_o \left( \frac{V_o}{V_{\text{IN}}} \right) \text{, therefore:}
\]

\[
L_1 = \frac{V_{\text{IN}} I_{\text{ON}}}{0.4 I_o \left( \frac{V_o}{V_{\text{IN}}} \right)} \text{ and since } t_{\text{ON}} = \frac{T (V_o - V_{\text{IN}})}{V_o}
\]

\[
L_1 = \frac{2.5 V_{\text{IN}}^2 (V_o - V_{\text{IN}})}{f I_o V_o^2}
\]

(25)

where: \( L_1 \) is in henrys, \( f \) is the switching frequency in Hz

To apply the above theory, a complete step-up switching regulator is shown in Figure 30. Since \( V_{\text{IN}} \) is 5V, \( V_{\text{REF}} \) is tied to \( V_{\text{IN}} \). The input voltage is divided by 2 to bias the error amplifier’s inverting input. The output voltage is:

\[
V_{\text{OUT}} = \left( 1 + \frac{R_2}{R_1} \right) \times V_{\text{INV}} = 2.5 \times \left( 1 + \frac{R_2}{R_1} \right)
\]

(26)

The network D1, C1 forms a slow start circuit.
This holds the output of the error amplifier initially low thus reducing the duty-cycle to a minimum. Without the slow start circuit the inductor may saturate at turn-on because it has to supply high peak currents to charge the output capacitor from 0V. It should also be noted that this circuit has no supply rejection. By adding a reference voltage at the non-inverting input to the error amplifier, see Figure 31, the input voltage variations are rejected.

The LM3524D can also be used in inductorless switching regulators. Figure 32 shows a polarity inverter which if connected to Figure 30 provides a −15V unregulated output.

![Figure 30. 15V, 0.5A Step-Up Switching Regulator](image)

L1 = > 25 turns No. 24 wire on Ferroxcube No. K300502 Toroid core.

![Figure 31. Replacing R3/R4 Divider in Figure 30 with Reference Circuit Improves Line Regulation](image)

![Figure 32. Polarity Inverter Provides Auxiliary −15V Unregulated Output from Circuit of Figure 30](image)
## REVISION HISTORY

### Changes from Revision D (May 2013) to Revision E

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## PACKAGING INFORMATION

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(1) The marketing status values are defined as follows:
- **ACTIVE**: Product device recommended for new designs.
- **LIFEBUY**: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
- **NRND**: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
- **PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.
- **OBSOLETE**: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check [http://www.ti.com/productcontent](http://www.ti.com/productcontent) for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS)**: TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt)**: This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br)**: TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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### TAPE AND REEL INFORMATION

#### TAPE DIMENSIONS

- **K0**: Dimension designed to accommodate the component width
- **B0**: Dimension designed to accommodate the component length
- **A0**: Dimension designed to accommodate the component thickness
- **W**: Overall width of the carrier tape
- **P1**: Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

- **Pocket Quadrants**: Q1, Q2, Q3, Q4
- **Sprocket Holes**: User Direction of Feed

*All dimensions are nominal*

<table>
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<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Reel Diameter (mm)</th>
<th>Reel Width W1 (mm)</th>
<th>A0 (mm)</th>
<th>B0 (mm)</th>
<th>K0 (mm)</th>
<th>P1 (mm)</th>
<th>W (mm)</th>
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<td>D</td>
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**TAPE AND REEL BOX DIMENSIONS**

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<th>SPQ</th>
<th>Length (mm)</th>
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*All dimensions are nominal*
D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

⚠️ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0.15) each side.

⚠️ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0.43) each side.
E. Reference JEDEC MS-012 variation AC.

4040047-6/M 06/11
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